



LHC Injectors Upgrade

Beam Gas Ionization monitor for PS

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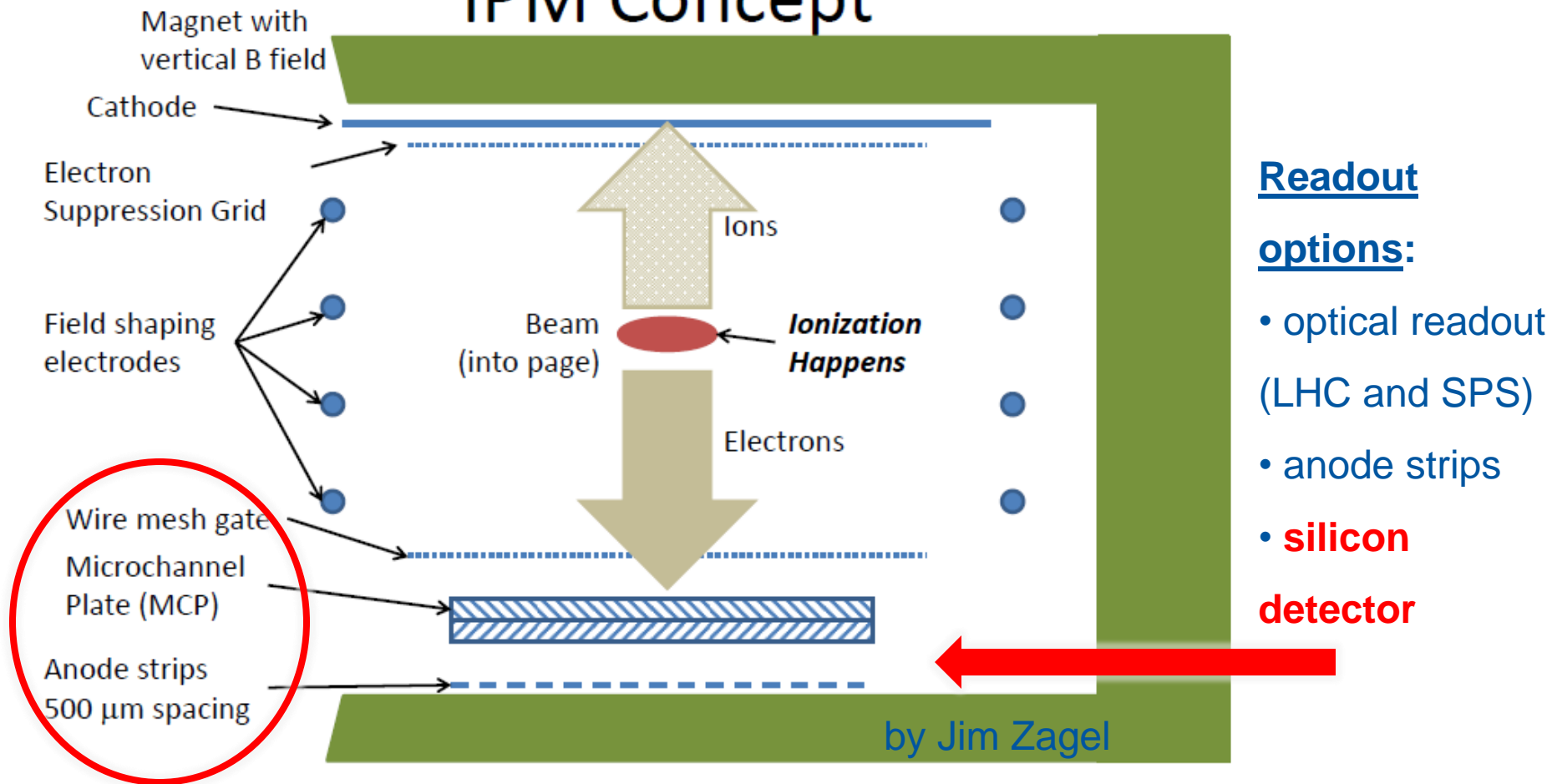
Medipix3 open meeting, November 20th, 2013

Introduction

- Beam Gas Ionization monitors (BGI) is a device to measure transverse beam size (and therefore **beam emittance**) due to ionization of rest gas in the vacuum pipe.
- BGIs operate on many machines, also at CERN: LHC, SPS, LEIR
- Optimizing beam emittance is crucial for HL-LHC.
- Emittance produced in pre-accelerators cannot be improved.
- PS is a machine where a lot of gymnastics with beam is done – many processes can affect emittance.
- Therefore strong need to measure and control emittance in PS.

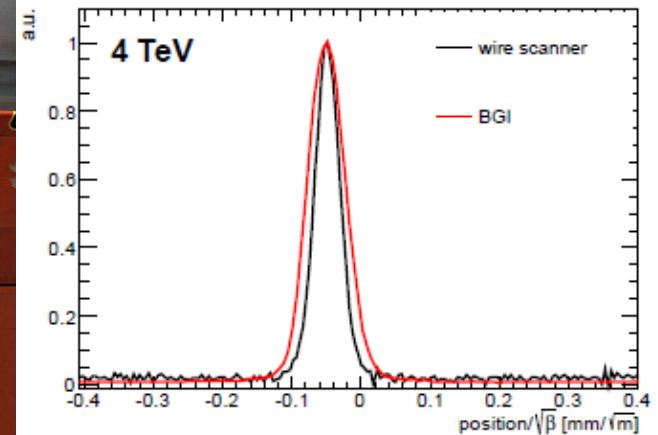
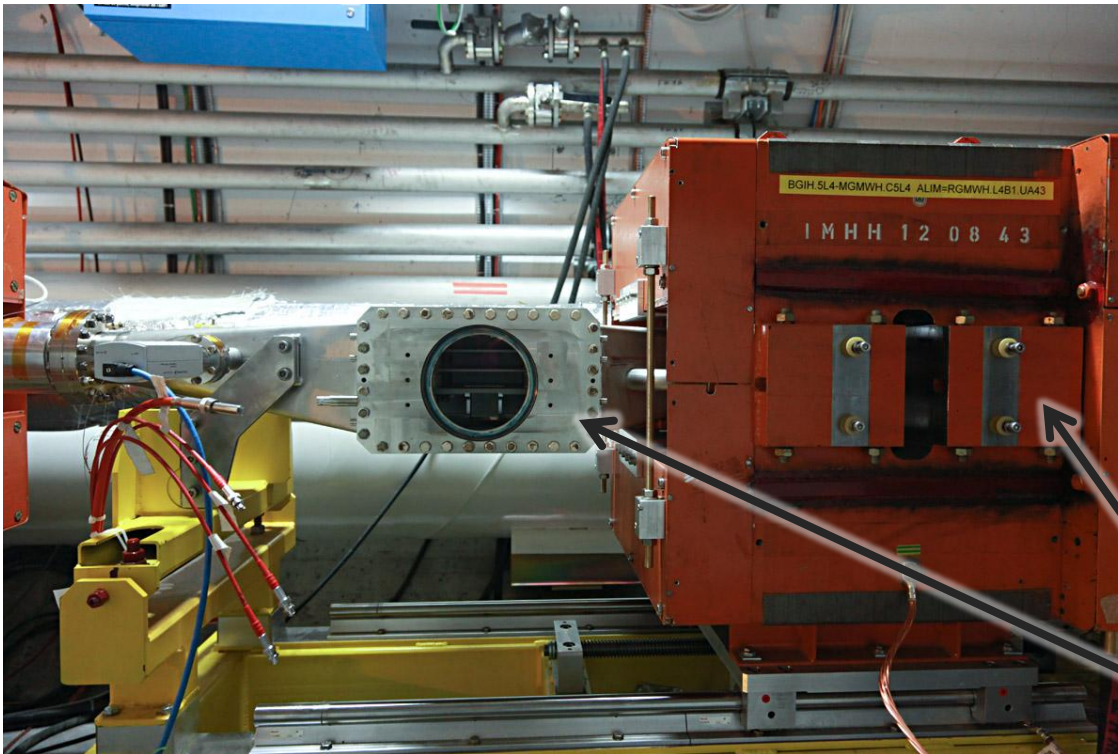
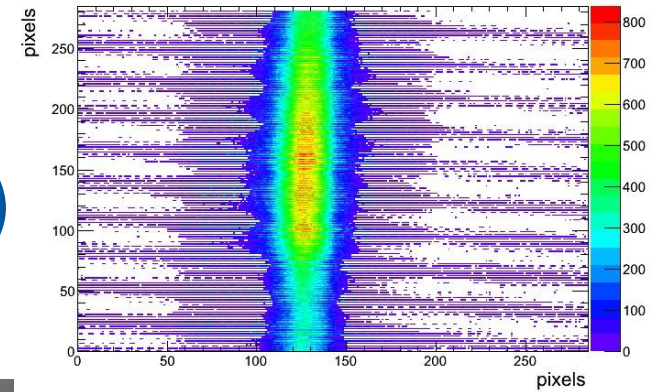
Beam gas ionization monitor

IPM Concept



Current experience: LHC and SPS BGIs (also LEIR)

B2V 2D image



Example of ion beam measurement in LHC.

Magnet

HV cage

PS BGI basic specification

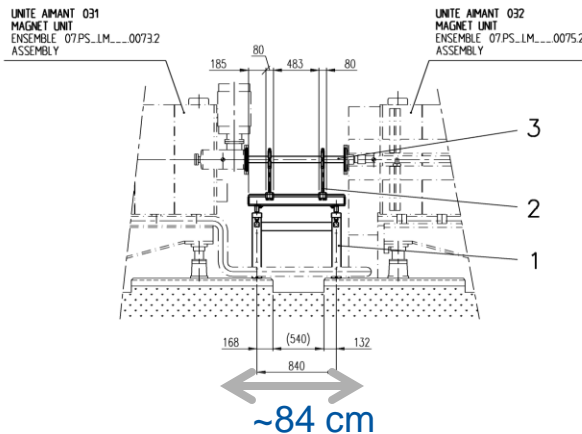
- Typical beam size: 0.5-5 mm (LHC beams), cover ~ 5 cm
- maximum 72 bunches max, 25 ns bunch spacing
- 10^{12} protons per bunch, 10^{10} Pb⁸²⁺ions per bunch
- bunch properties change during cycle (splitting, merging)
- Basic mode: continuous measurement during the cycle averaged over all bunches (2.1 s) – 0.1-1 kHz
- Normal mode: continuous bunch-by-bunch measurement during the cycle - 0.1-1 kHz
- Burst mode: turn-by-turn measurements (1 turn = 2.1 us) at chosen moment of the cycle (for about 5000 turns)

Choice of principle

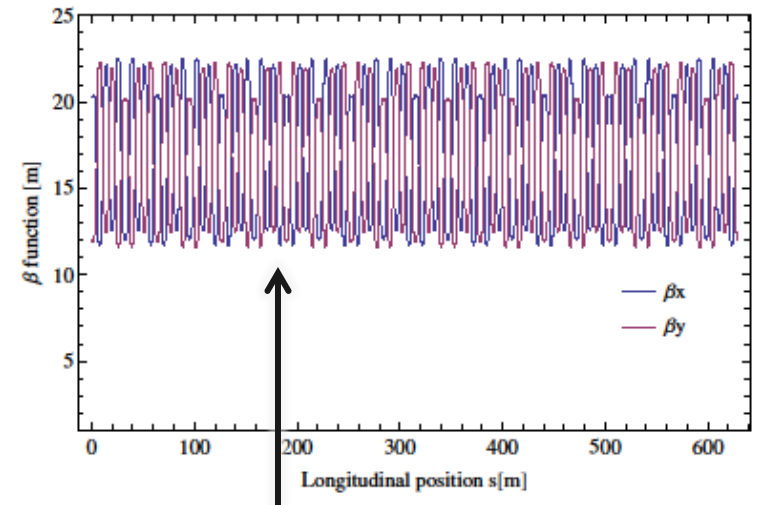
- Electron or ions?
 - Fast measurement = **electrons**.
 - But magnets needed (~ 0.2 T).
- Optical or electrical or Si pixel readout system?
 - **Electrical/Si pixel readout easier fulfills spec.**
 - Electrical readout allows to save space (needed by optical mirror) and construct magnets with smaller aperture (impact on cost).
 - Beams are large, no need for optical readout.
 - Probably **Si pixels and Timepix chip will allow to get rid of MCP**

Location

- Horizontal device: SS32
- Vertical device: SS33



SS should be ok for radiation levels once the CT extraction replaced definitely by MTE



SS32



PS BGI and Timepix3

- between 300 and 50000 electrons/bunch (25 ns) generated due to ionization – large dynamic range.
- Electron energy 2-20 keV (adjustable, regulate pixel occupancy).
- Electric “shutter” (wire mesh) to gate on electrons from a chosen bunch only – this will be tricky because of bunch splitting procedure.
- At first look Timepix3 should withstand the radiation in PS.
- Its main advantage over electrical readout (anode strips) is lack of MCP, which suffers from non-uniform gain and ageing.

Time line and budget

- October 2013: start working on electrical/Silicon readout magnet simulations, design (or integration of other design)
- Spring 2014: technical proposal and decision
- Summer 2014-end of 2015: construction
- Winter 2015/2016 installation of prototype
- Budget has been allocated for feasibility study.

Summary

- Need of continuous beam emittance measurement in PS.
- Study started.
- Use of Si detector with Timepix3 chip seem to fulfill main requirements and allows to get rid of MCP.
- Silicon detector in BGI has never been used before.
- Prototype installation in winter 2015/16.

THANK YOU FOR YOUR ATTENTION

Backup slides

PS BGI A.D. 1968

THE CPS GAS-IONIZATION BEAM SCANNER

C.D. Johnson and L. Thorndahl
CERN, Geneva, Switzerland

PAC 1969

Summary

A non-destructive beam scanner was installed in the CPS ring early in 1968. Deriving a signal from the electrons liberated by the proton beam from the residual gas in the vacuum chamber and using a crossed electric and magnetic fields system of electrostatic and magnetic fields, the scanner gives the projected density distributions in the horizontal and vertical planes. Spatial resolution is better than 1 mm.

An important feature is the use of a single collector which scans the electrons from a slice of the beam through a zero equipotential surface. The equipotential surfaces are arranged to scan the beam and scanning is accomplished by displacing these equipotentials in the region of the beam. In particular, the zero equipotential, which always passes through the detector, is scanned right across the beam.

References
1. HORNESTRA, F. and BELUCA, W.H., Non-destructive beam profile detection systems for the ZGS, ANL internal report, 1967
Argonne, 1967

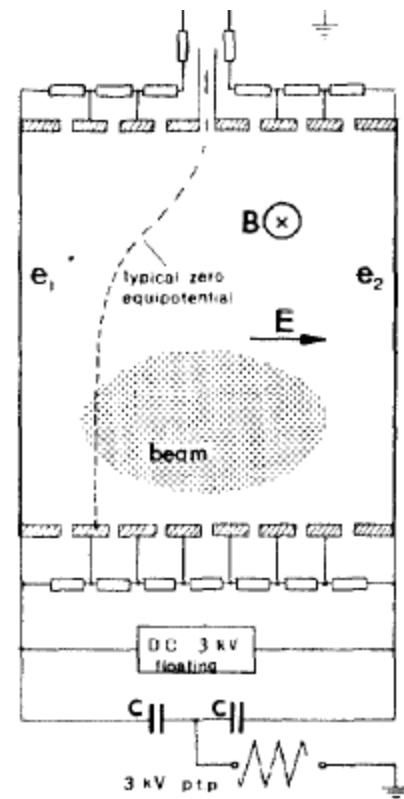


Fig. 1

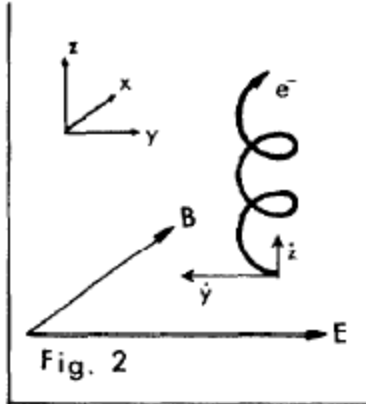


Fig. 2

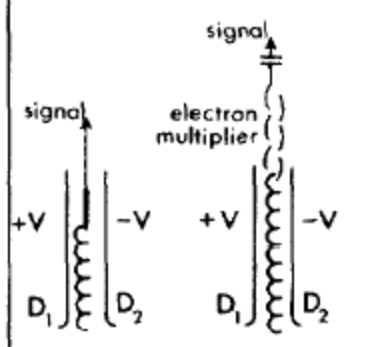


Fig. 3a

Fig. 3b

IBS detectors

PS beams – examples

beam	SPS ftarget	TOF	EASTA	LHC 25 ns 72 bunches
Injection				
Ek [GeV]	2.0	2.0	2.0	2.0/1.4
Bunch nrb	8	1	1	6
Charges/b	3.1E12	8E12	4E11	1.5E12
Bunch len [ns]	150	190	170	180
$\epsilon_{H/V}$ [$\mu\text{m rad}$]	7.6/5.4	9.2/7.8	1.5/1.5	1.5
Extraction				
Ek [GeV]	14	20	24	26
Bunch nbr	420 (deb)	1	1	72
Charges/b	$\sim 5\text{E}10$	8E12	3.8E11	1.25E11
Bunch len [ns]	5	50	debunched	4
$\epsilon_{H/V}$ [$\mu\text{m rad}$]	11/8	12/10	-	1.5

EDMS 1157752, document in work

Beam specs to be updated after October review of RLIUP.

Magnets

by Dominique Bodart

- Requirement: good field region of 50mm, field 0.2 T
- Iron yoke type corrector magnet
- Number of corrector magnets to close the bump: 1
- 2 types of magnets shall be used because of vacuum chamber shape
- Particular attention on vertical corrector because the aperture needed is 180 mm
- Preliminary study ongoing, 2D simulation show acceptable field homogeneity
- Cost 100-200kCHF (for 6 magnets including spares)

Preliminary OP specification:

- Maximum **number of bunches: 72**
- bunch-by-bunch and turn-by-turn at injection, extraction (maybe transition) for 5-10 ms (**5000 turns**) – **burst mode**.
- A sliding window of burst mode.
- No multiplexing (H and V at the same time).
- **Beam size: 0.5-60 mm** (that is difficult).
- No need during RF bunch splitting/merging – results difficult to interpret in H plane due to large dispersion.
- **Normal mode: 100-1000 acquisitions/s** (bbb)
- Used mainly for qualification of LHC beams during filling – must work in pulse-to-pulse mode (PPM).

Radiation in SS31 and SS32

Radiation Levels CPS_RS + HLD

